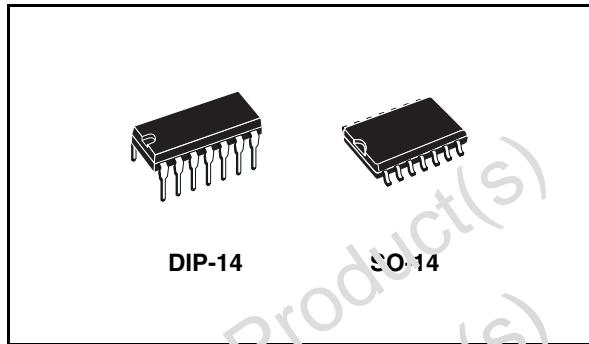


## Quad 2-input and gate (open drain)

**Features**

- High Speed:  
 $t_{PD} = 7\text{ns}$  (Typ.) at  $V_{CC} = 6\text{V}$
- Low power dissipation:  
 $I_{CC} = 1\mu\text{A}$  (Max.) at  $T_A = 25^\circ\text{C}$
- High noise immunity:  
 $V_{NIH} = V_{NIL} = 28\%$   $V_{CC}$  (Min.)
- Balanced propagation delays:  
 $t_{PLH} \approx t_{PHL}$
- Wide operating voltage range:  
 $V_{CC}$  (Opr) = 2V to 6V
- Pin and function compatible with 74 series 09

**Description**

The M74HC09 is an high speed CMOS Quad 2-input open drain and gate fabricated with silicon gate C<sup>2</sup>MOS technology.

The internal circuit is composed of 3 stages including buffer output, which enables high noise immunity and stable output.

All inputs are equipped with protection circuits against static discharge and transient excess voltage.

**Order codes**

Part number	Package	Packaging
M74HC09B1R	DIP-14	Tube
M74HC09M1R	SO-14	Tube
M74HC09RM13TR	SO-14	Tape and reel

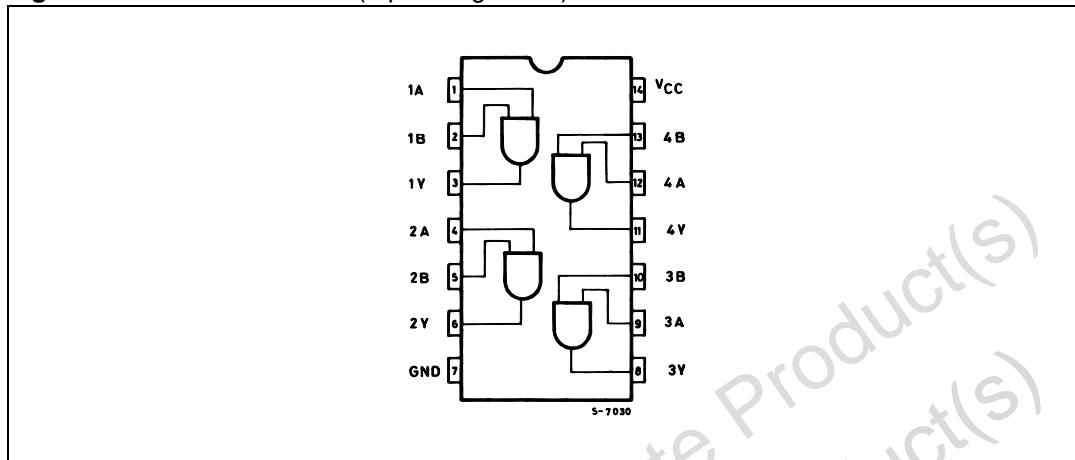
## Contents

<b>1</b>	<b>Pin settings</b>	<b>3</b>
1.1	Pin connection	3
1.2	Pin description	3
<b>2</b>	<b>Device summary</b>	<b>4</b>
<b>3</b>	<b>Maximum rating</b>	<b>5</b>
3.1	Recommended operating conditions	5
<b>4</b>	<b>Electrical characteristics</b>	<b>6</b>
<b>5</b>	<b>Test circuit</b>	<b>8</b>
<b>6</b>	<b>Waveforms</b>	<b>8</b>
<b>7</b>	<b>Package mechanical data</b>	<b>9</b>
<b>8</b>	<b>Revision history</b>	<b>12</b>

# 1 Pin settings

## 1.1 Pin connection

Figure 1. Pin connection (top through view)



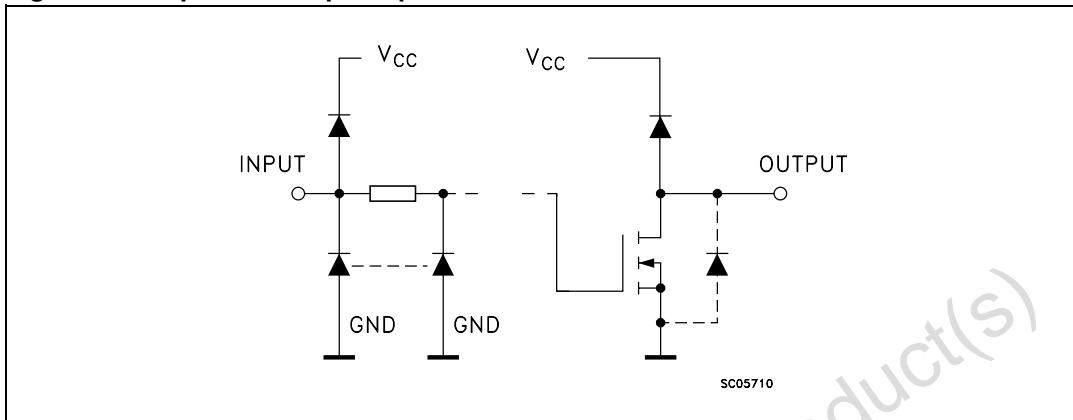
## 1.2 Pin description

Table 1. Pin description

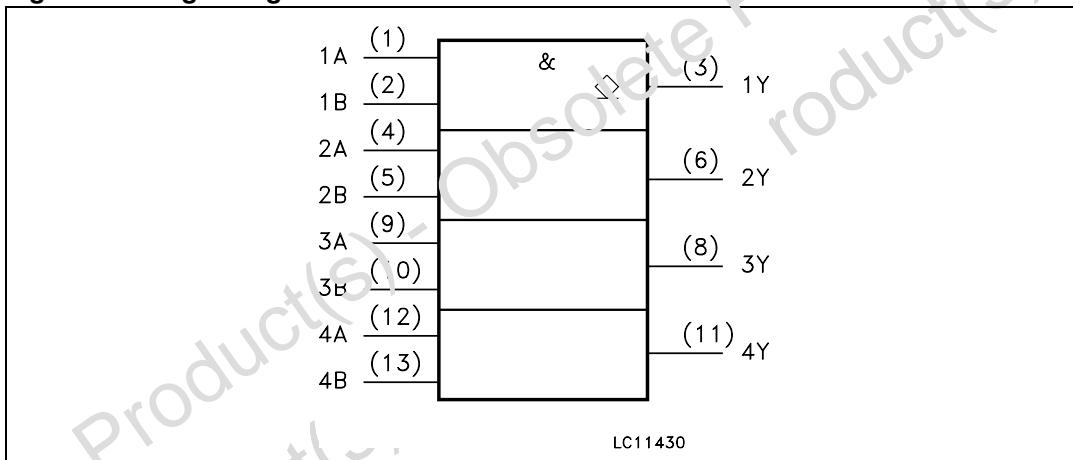
Pin N°	Symbol	Name and function
1, 4, 9, 12	1A to 4A	Data Inputs
2, 5, 10, 13	1B to 4B	Data Inputs
3, 6, 8, 11	1Y to 4Y	Data Outputs
7	GND	Ground (0V)
14	V <sub>CC</sub>	Positive Supply Voltage

## 2 Device summary

**Figure 2. Input and output equivalent circuit**



**Figure 3. Logic diagram**



**Table 2. Truth table**

A	B	Y
L	L	L
L	H	L
H	L	L
H	H	Z

Note: Z : High Impedance

### 3 Maximum rating

Stressing the device above the rating listed in the “Absolute Maximum Ratings” table may cause permanent damage to the device. These are stress ratings only and operation of the device at these or any other conditions above those indicated in the Operating sections of this specification is not implied. Exposure to Absolute Maximum Rating conditions for extended periods may affect device reliability. Refer also to the STMicroelectronics SURE Program and other relevant quality documents.

**Table 3. Absolute maximum ratings**

Symbol	Parameter	Value	Unit
$V_{CC}$	Supply Voltage	-0.5 to +7	V
$V_I$	DC Input Voltage	-0.5 to $V_{CC} + 0.5$	V
$V_O$	DC Output Voltage	-0.5 to $V_{CC} + 0.5$	V
$I_{IK}$	DC Input Diode Current	$\pm 20$	mA
$I_{OK}$	DC Output Diode Current	$\pm 20$	mA
$I_O$	DC Output Current	$\pm 25$	mA
$I_{CC}$ or $I_{GND}$	DC $V_{CC}$ or Ground Current	$\pm 50$	mA
$P_D$	Power Dissipation	500 <sup>(1)</sup>	mW
$T_{stg}$	Storage Temperature	-65 to +150	°C
$T_L$	Lead Temperature (10 sec)	300	°C

1. 500mW at 65 °C, derate to 300mW by 10mW/°C from 65°C to 85°C

### 3.1 Recommended operating conditions

**Table 4. Recommended operating conditions**

Symbol	Parameter	Value	Unit	
$V_{CC}$	Supply Voltage	2 to 6	V	
$V_I$	Input Voltage	0 to $V_{CC}$	V	
$V_O$	Output Voltage	0 to $V_{CC}$	V	
$T_{op}$	Operating Temperature	-55 to 125	°C	
$t_p, t_f$	Input Rise and Fall Time	$V_{CC} = 2.0V$	0 to 1000	ns
		$V_{CC} = 4.5V$	0 to 500	ns
		$V_{CC} = 6.0V$	0 to 400	ns

## 4 Electrical characteristics

Table 5. DC specifications

Symbol	Parameter	Test condition		Value						Unit	
		$V_{CC}$ (V)		$T_A = 25^\circ C$			$-40 \text{ to } 85^\circ C$		$-55 \text{ to } 125^\circ C$		
				Min	Typ	Max	Min	Max	Min	Max	
$V_{IH}$	High Level Input Voltage	2.0		1.5			1.5		1.5		V
		4.5		3.15			3.15		3.15		
		6.0		4.2			4.2		4.2		
$V_{IL}$	Low Level Input Voltage	2.0				0.5		0.5		0.5	V
		4.5				1.35		1.35		1.35	
		6.0				1.8		1.8		1.8	
$V_{OL}$	Low Level Output Voltage	2.0	$I_O = 20\mu A$		0.0	0.1		0.1		0.1	V
		4.5	$I_O = 20\mu A$		0.0	0.1		0.1		0.1	
		6.0	$I_O = 20\mu A$		0.7	0.1		0.1		0.1	
		4.5	$I_O = 4.0mA$		0.17	0.26		0.33		0.40	
		6.0	$I_O = 5.2mA$		0.18	0.26		0.33		0.40	
$I_I$	Input Leakage Current	6.0	$V_I = V_{CC}$ or GND			$\pm 0.1$		$\pm 1$		$\pm 1$	$\mu A$
$I_{OZ}$	Output Leakage Current	6.0	$V_I = V_{IH}$ or $V_{IL}$ $V_O = V_{CC}$ or GND			$\pm 0.5$		$\pm 5$		$\pm 10$	$\mu A$
$I_{CC}$	Quiescent Supply Current	6.0	$V_I = V_{CC}$ or GND			1		10		20	$\mu A$

**Table 6. AC electrical characteristics ( $C_L = 50 \text{ pF}$ , Input  $t_r = t_f = 6\text{ns}$ )**

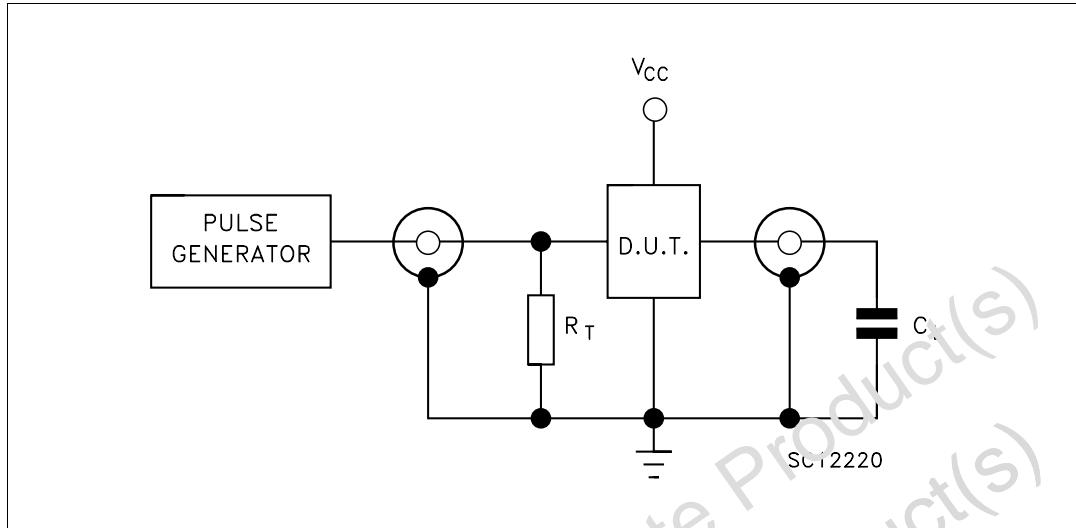
Symbol	Parameter	Test Condition		Value						Unit	
		$V_{CC}$ (V)		$T_A = 25^\circ\text{C}$			$-40 \text{ to } 85^\circ\text{C}$		$-55 \text{ to } 125^\circ\text{C}$		
				Min	Typ	Max	Min	Max	Min		
$t_{THL}$	Output Transition Time	2.0			30	75		95		110	ns
		4.5			8	15		19		22	
		6.0			7	13		16		19	
$t_{PLZ}$	Propagation Delay Time	2.0	$R_L = 1 \text{ k}\Omega$		10	75		95		110	ns
		4.5			8	15		19		22	
		6.0			7	13		16		19	
$t_{PZL}$	Propagation Delay Time	2.0	$R_L = 1 \text{ k}\Omega$		20	75		95		110	ns
		4.5			8	15		19		22	
		6.0			7	13		16		19	

**Table 7. Capacitive characteristics**

Symbol	Parameter	Test condition		Value						Unit	
		$V_{CC}$ (V)		$T_A = 25^\circ\text{C}$			$-40 \text{ to } 85^\circ\text{C}$		$-55 \text{ to } 125^\circ\text{C}$		
				Min	Typ	Max	Min	Max	Min		
$C_{IN}$	Input Capacitance	5.0			5	10		10		10	pF
$C_{OUT}$	Output Capacitance	5.0			10						pF
$C_{PD}$	Power Dissipation Capacitance (note 1)	5.0			6.5						pF

## 5 Test circuit

Figure 4. Test circuit

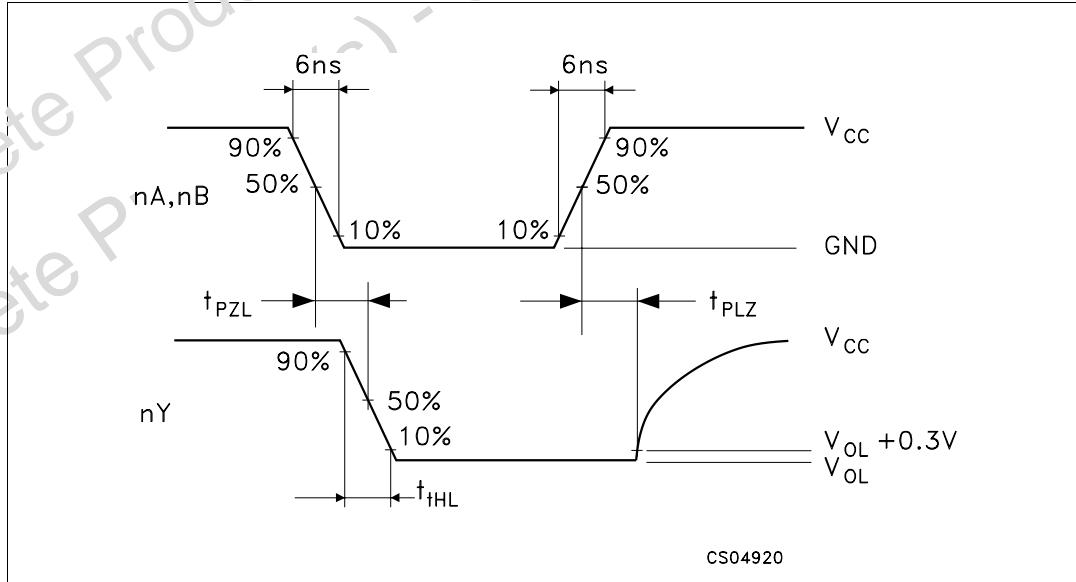


Note:  $C_L = 50\text{pF}$  or equivalent (includes jig and probe capacitance)

$R_T = Z_{OUT}$  of pulse generator (typically  $50\Omega$ )

## 6 Waveforms

Figure 5. Waveform - propagation delay ( $f = 1\text{MHz}$ ; 50% duty cycle)

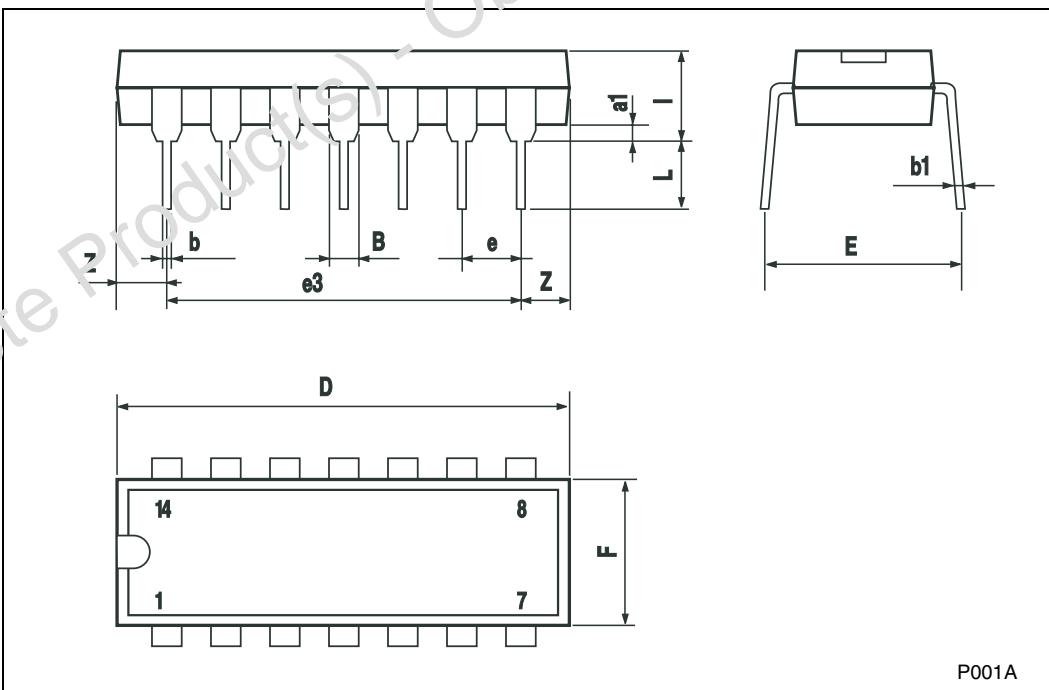


## 7 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect . The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: [www.st.com](http://www.st.com)

Plastic DIP-14 MECHANICAL DATA						
DIM.	mm.			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
a1	0.51			0.020		
B	1.39		1.65	0.055		0.065
b		0.5			0.020	
b1		0.25			0.010	
D			20			0.78 <sup>1</sup>
E		8.5			0.335	
e		2.54			0.100	
e3		15.24			0.600	
F			7.1			0.280
I			5.1			0.201
L		3.3			0.130	
Z	1.27		2.54	0.050		0.100

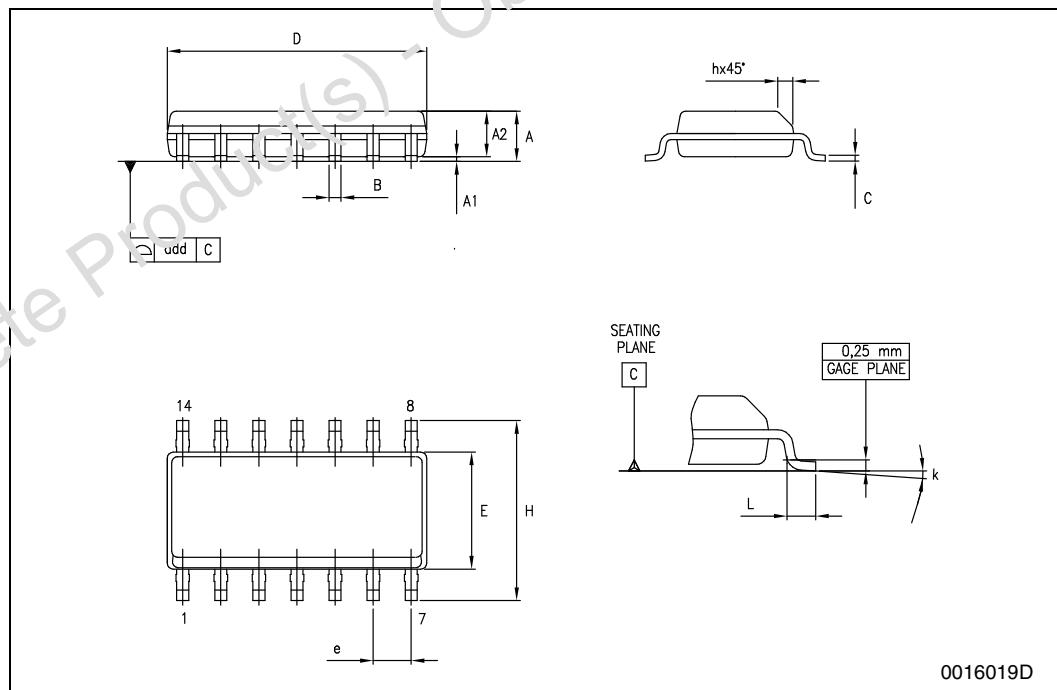
DIM.	mm.			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
a1	0.51			0.020		
B	1.39		1.65	0.055		0.065
b		0.5			0.020	
b1		0.25			0.010	
D			20			0.78 <sup>1</sup>
E		8.5			0.335	
e		2.54			0.100	
e3		15.24			0.600	
F			7.1			0.280
I			5.1			0.201
L		3.3			0.130	
Z	1.27		2.54	0.050		0.100



P001A

**SO-14 MECHANICAL DATA**

DIM.	mm.			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A	1.35		1.75	0.053		0.069
A1	0.1		0.25	0.004		0.010
A2	1.10		1.65	0.043		0.065
B	0.33		0.51	0.013		0.020
C	0.19		0.25	0.007		0.010
D	8.55		8.75	0.337		0.344
E	3.8		4.0	0.150		0.157
e		1.27			0.050	
H	5.8		6.2	0.228		0.244
h	0.25		0.50	0.010		0.020
L	0.4		1.27	0.016		0.050
k	0°		8°	0°		8°
ddd			0.100			0.004



## 8 Revision history

**Table 8. Revision history**

Date	Revision	Changes
07-Aug-2001	1	First Release
19-May-2006	2	New template, deleted TSSOP14 package information

**Please Read Carefully:**

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or any intellectual property contained therein.

**UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.**

**UNLESS EXPRESSLY APPROVED IN WRITING BY AN AUTHORIZED REPRESENTATIVE OF ST, ST PRODUCTS ARE NOT DESIGNED, AUTHORIZED OR WARRANTED FOR USE IN MILITARY, AIR CRAFT, SPACE, LIFE SAVING, OR LIFE SUSTAINING APPLICATIONS, NOR IN PRODUCTS OR SYSTEMS, WHERE FAILURE OR MALFUNCTION MAY RESULT IN PERSONAL INJURY, DEATH, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE.**

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries.

Information in this document supersedes and replaces all information previously supplied.

The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

© 2006 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan - Malaysia - Malta - Morocco - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

[www.st.com](http://www.st.com)

